

Features

- Integrated analog input Class D audio amplifier driver in a small 16 pin package
- Floating inputs enable easy half bridge implementation
- Programmable bidirectional over-current protection with self-reset function
- Programmable preset deadtime for improved THD performances
- Start and stop click noise reduction
- High noise immunity
- ± 100 V ratings deliver up to 500 W in output power
- Operates up to 800 kHz
- RoHS compliant

Product Summary

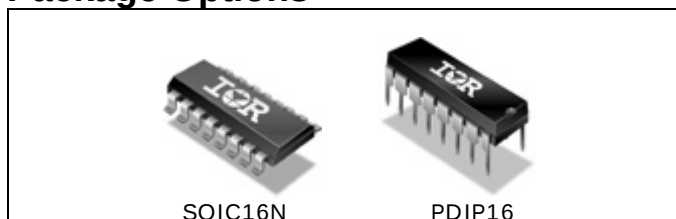
V_{OFFSET} (max)		± 100 V
Gate driver	lo+	1.0 A
	lo -	1.2 A
Selectable Deadtime		25/40/65/105 ns
OC protection delay (max)		500 ns
DC offset		<20 mV
PWM frequency		~800 kHz
Error amplifier open loop gain		>60 dB
THD+N* (1kHz, 50W, 4 Ω)		0.01 %
Residual Noise* (AES-17 Filter)		200 μ Vrms

* measured with recommended circuit

Typical Applications

- Home theater systems
- Mini component stereo systems
- Powered speaker systems
- General purpose audio power amplifiers

Package Options



Typical Connection Diagram

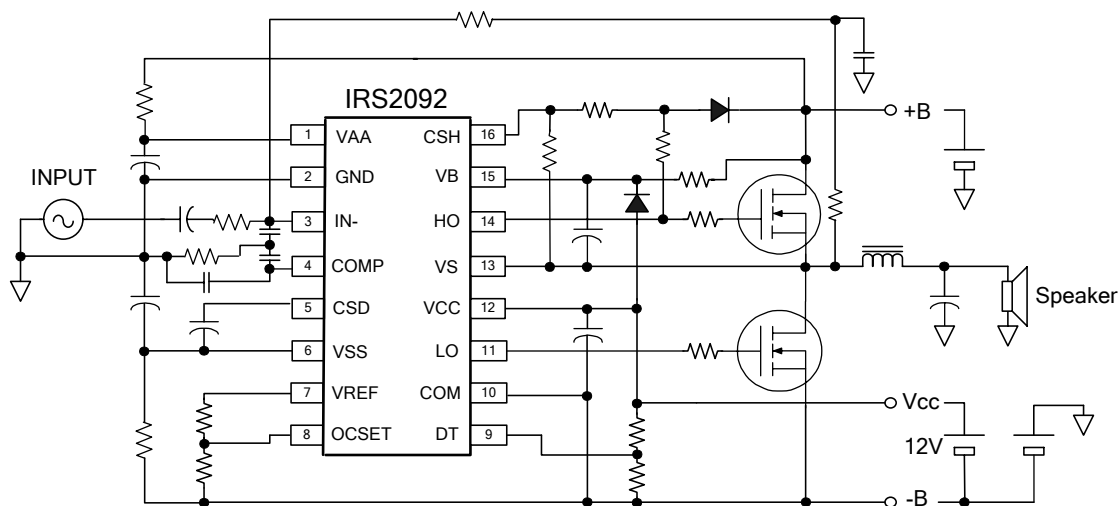


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Description

The IRS2092 is a high voltage, high performance Class D audio amplifier driver with PWM modulator and protection. In conjunction with two external MOSFET and a few external components, a complete Class D audio amplifier with protection can be realized.

International Rectifier's proprietary noise isolation technology allows high current gate drive stage and high speed low noise error amplifier reside on a single small silicon die.

Open elements of PWM modulator section allow flexible PWM topology implementation.

The diagram shows the internal architecture of the ADXL071. Key components include:

- Input Stage:** The IN pin connects to an OTA (Operational Transconductance Amplifier) and a COMP (Comparator). VAA and VSS provide biasing.
- Floating Input:** A dashed box labeled "FLOATING INPUT" contains the COMP and two HV LEVEL SHIFT blocks.
- Protection Control:** Receives CSD input and provides feedback to the HV LEVEL SHIFT blocks.
- Control Logic:** Includes a DEAD TIME block and logic involving SD and DT pins.
- Output Stages:** HIGH SIDE CS and LOW SIDE CS drivers, followed by output buffers connected to HO, VS, LO, COM, and OCSET pins.

Refer to IRAUDAMP5 reference design for details.

Qualification Information[†]

Qualification Level		Industrial ^{††} (per JEDEC JESD 47E)	
		Comments: This IC has passed JEDEC's Industrial qualification. IR's Consumer qualification level is granted by extension of the higher Industrial level.	
Moisture Sensitivity Level		SOIC16N	MSL3 ^{†††} (per IPC/JEDEC J-STD-020C)
		DIP16	
ESD	Machine Model	Class B (per JEDEC standard JESD22-A114D)	
	Human Body Model	Class 2 (per EIA/JEDEC standard EIA/JESD22-A115-A)	
	Charged Device Model	Class IV (per JEDEC standard JESD22-C101C)	
IC Latch-Up Test		Class I, Level A (per JESD78A)	
RoHS Compliant		Yes	

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM; all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min	Max	Units
V_B	High side floating supply voltage	-0.3	220	V
V_S	High side floating supply voltage (Note2)	$V_B - 20$	$V_B + 0.3$	
V_{HO}	High side floating output voltage	$V_S - 0.3$	$V_B + 0.3$	
V_{CSH}	CSH pin input voltage	$V_S - 0.3$	$V_B + 0.3$	
V_{CC}	Low side fixed supply voltage (Note2)	-0.3	20	
V_{LO}	Low side output voltage	-0.3	$V_{CC} + 0.3$	
V_{AA}	Floating input positive supply voltage (Note2)	(See I_{AAZ})	210	
V_{SS}	Floating input negative supply voltage (Note2)	-1 (See I_{SSZ})	GND + 0.3	
V_{GND}	Floating input supply ground voltage	$V_{SS} - 0.3$ (See I_{SSZ})	$V_{AA} + 0.3$ (See I_{AAZ})	mA
I_{IN-}	Inverting input current (Note1)	---	± 3	
V_{CSD}	SD pin input voltage	$V_{SS} - 0.3$	$V_{AA} + 0.3$	V
V_{COMP}	COMP pin input voltage	$V_{SS} - 0.3$	$V_{AA} + 0.3$	
V_{DT}	DT pin input voltage	-0.3	$V_{CC} + 0.3$	
V_{OCSET}	OCSET pin input voltage	-0.3	$V_{CC} + 0.3$	
I_{AAZ}	Floating input positive supply zener clamp current (Note2)	---	20	mA
I_{SSZ}	Floating input negative supply zener clamp current (Note2)	---	20	
I_{CCZ}	Low side supply zener clamp current (Note3)	---	10	
I_{BSZ}	Floating supply zener clamp current (Note3)	---	10	
I_{OREF}	Reference output current	---	5	
dV_S/dt	Allowable V_S voltage slew rate	---	50	V/ns
dV_{SS}/dt	Allowable V_{SS} voltage slew rate (Note3)	---	50	V/ms
Pd	Maximum power dissipation @ $T_A \leq +25^\circ\text{C}$	SOIC16N	1.0	W
		DIP16	1.6	
R_{thJA}	Thermal resistance, Junction to ambient	SOIC16N	115	$^\circ\text{C}/\text{W}$
		DIP16	75	
T_J	Junction Temperature	---	150	$^\circ\text{C}$
T_S	Storage Temperature	-55	150	$^\circ\text{C}$
T_L	Lead temperature (soldering, 10 seconds)	---	300	$^\circ\text{C}$

Note1: $IN-$ contains clamping diode to GND.

Note2: $V_{DD} - IN+$, GND - V_{SS} , $V_{CC} - COM$ and $V_B - V_S$ contain internal shunt zener diodes. Please note that the voltage ratings of these can be limited by the clamping current.

Note3: For the rising and falling edges of step signal of 10 V. $V_{SS} = 15\text{ V}$ to 200 V.

Recommended Operating Conditions

For proper operation, the device should be used within the recommended conditions below. The V_S and COM offset ratings are tested with supplies biased at $V_{AA}-V_{SS}=10\text{ V}$, $V_{CC}=12\text{ V}$ and $V_B-V_S=12\text{ V}$. All voltage parameters are absolute voltages referenced to COM; all currents are defined positive into any lead.

Symbol	Definition	Min.	Max.	Units
V_B	High side floating supply absolute voltage	$V_S + 10$	$V_S + 18$	V
V_S	High side floating supply offset voltage	(Note 1)	200	
I_{AAZ}	Floating input positive supply zener clamp current	1	11	mA
I_{SSZ}	Floating input negative supply zener clamp current	1	11	
V_{SS}	Floating input supply absolute voltage	0	200	V
V_{HO}	High side floating output voltage	V_S	V_B	
V_{CC}	Low side fixed supply voltage	10	18	
V_{LO}	Low side output voltage	0	V_{CC}	
V_{GND}	GND pin input voltage	V_{SS} (Note 3)	V_{AA} (Note 3)	
V_{IN-}	Inverting input voltage	$V_{GND} - 0.5$	$V_{GND} + 0.5$	
V_{CSD}	CSD pin input voltage	V_{SS}	V_{AA}	
V_{COMP}	COMP pin input voltage	V_{SS}	V_{AA}	
C_{COMP}	COMP pin phase compensation capacitor to GND	1	-	nF
V_{DT}	DT pin input voltage	0	V_{CC}	V
I_{OREF}	Reference output current to COM (Note 2)	0.3	0.8	mA
V_{OCSET}	OCSET pin input voltage	0.5	5	V
V_{CSH}	CSH pin input voltage	V_S	V_B	
dV_{SS}/dt	Allowable V_{SS} voltage slew rate upon power-up (Note4)	-	50	V/ms
I_{PW}	Input pulse width	10 (Note 5)	-	ns
f_{SW}	Switching Frequency	-	800	kHz
T_A	Ambient Temperature	-40	125	°C

Note 1: Logic operational for V_S equal to -5 V to $+200\text{ V}$. Logic state held for V_S equal to -5 V to $-V_{BS}$.

Note 2: Nominal voltage for V_{REF} is 5.1 V . I_{OREF} of $0.3 - 0.8\text{ mA}$ dictates total external resistor value on V_{REF} to be $6.3\text{ k}\Omega$ to $16.7\text{ k}\Omega$.

Note 3: GND input voltage is limited by I_{AAZ} and I_{SSZ} .

Note 4: V_{SS} ramps up from 0 V to 200 V .

Note 5: Output logic status may not respond correctly if input pulse width is smaller than the minimum pulse width.

Electrical Characteristics

$V_{CC}, V_{BS} = 12\text{ V}$, $V_{SS} = V_S = \text{COM} = 0\text{ V}$, $V_{AA} = 10\text{ V}$, $C_L = 1\text{ nF}$ and $T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
Low Side Supply						
UV _{CC+}	V _{CC} supply UVLO positive threshold	8.4	8.9	9.4	V	
UV _{CC-}	V _{CC} supply UVLO negative threshold	8.2	8.7	9.2		
UV _{CCHYS}	UV _{CC} hysteresis	-	0.2	-		
I _{QCC}	Low side quiescent current	-	-	3	mA	V _{DT} =V _{CC}
V _{CLAMPL}	Low side zener diode clamp voltage	19.6	20.4	21.6	V	I _{CC} =5 mA
High Side Floating Supply						
UV _{BS+}	High side well UVLO positive threshold	8.0	8.5	9.0	V	
UV _{BS-}	High side well UVLO negative threshold	7.8	8.3	8.8		
UV _{BSHYS}	UV _{BS} hysteresis	-	0.2	-		
I _{QBS}	High side quiescent current	-	-	1	mA	
I _{LKH}	High to Low side leakage current	-	-	50	μA	V _B =V _S =200 V
V _{CLAMPH}	High side zener diode clamp voltage	19.6	20.4	21.6	V	I _{BS} =5 mA
Floating Input Supply						
UV _{AA+}	VA+, VA- floating supply UVLO positive threshold from V _{SS}	8.2	8.7	9.2	V	V _{SS} =0 V, GND pin floating
UV _{AA-}	VA+, VA- floating supply UVLO negative threshold from V _{SS}	7.7	8.2	8.7		V _{SS} =0 V, GND pin floating
UV _{AAHYS}	UV _{AA} hysteresis	-	0.5	-		V _{SS} =0 V, GND pin floating
I _{QAA0}	Floating Input positive quiescent supply current	-	0.5	2	mA	V _{AA} =10 V, V _{SS} =0 V, V _{CSD} =VSS
I _{QAA1}	Floating Input positive quiescent supply current	-	8	11		V _{AA} =10 V, V _{SS} =0 V, V _{CSD} =VAA
I _{QAA2}	Floating Input positive quiescent supply current	-	8	11		V _{AA} =10 V, V _{SS} =0 V, V _{CSD} =GND
I _{LKM}	Floating input side to Low side leakage current	-	-	50	μA	V _{AA} =V _{SS} =V _{GND} =100 V
V _{CLAMPM+}	V _{AA} floating supply zener diode clamp voltage, positive, with respect to GND	6.0	7.0	8.0	V	I _{AA} =5 mA, I _{SS} =5 mA, V _{GND} =0 V, V _{CSD} =VSS
V _{CLAMPM-}	V _{SS} floating supply zener diode clamp voltage, negative, with respect to GND	-8.0	-7.0	-6.0		I _{AA} =5 mA, I _{SS} =5 mA, V _{GND} =0 V, V _{CSD} =VSS
Audio Input (V _{GND} =0, V _{AA} =5V, V _{SS} =-5V)						
V _{OS}	Input offset voltage	-15	0	15	mV	
I _{BIN}	Input bias current	-	-	40	nA	
BW	Small signal bandwidth	-	9	-	MHz	C _{COMP} =2 nF, R _f =3.3 kΩ
V _{COMP}	OTA Output voltage	V _{AA} -1	-	V _{SS} +1	V	
g _m	OTA transconductance	-	100	-	mS	V _{IN} =10 mV
G _V	OTA gain	60	-	-	dB	
V _{Nrms}	OTA input noise voltage	-	250	-	mVrms	BW=20 kHz, Resolution BW=22 Hz Fig.5
SR	Slew rate	-	±5	-	V/us	C _{COMP} =1 nF
CMRR	Common-mode rejection ratio	-	60	-	dB	
PSRR	Supply voltage rejection ratio	-	65	-		
PWM comparator						
V _{thPWM}	PWM comparator threshold in COMP	-	(V _{AA} -V _{SS})/2	-	V	
f _{OTA}	COMP pin star-up local oscillation	0.7	1.0	1.3	MHz	V _{CSD} =GND

	frequency					
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Protection						
V _{REF}	Reference output voltage	4.8	5.1	5.4	V	I _{OREF} =0.5 mA
V _{th} _{OCL}	Low side OC threshold in Vs	1.1	1.2	1.3		OCSET=1.2 V, Fig.6
V _{th} _{OCH}	High side OC threshold in V _{CSH}	1.1+ Vs	1.2+ Vs	1.3+ Vs		Vs=200 V,
V _{th} 1	CSD pin shutdown release threshold	0.62xV _{DD}	0.70xV _{DD}	0.78xV _{DD}		
V _{th} 2	CSD pin self reset threshold	0.26xV _{DD}	0.30xV _{DD}	0.34xV _{DD}		
I _{CSD+}	CSD pin discharge current	70	100	130	μA	V _{CSD} = V _{SS} +5 V
I _{CSD-}	CSD pin charge current	70	100	130		V _{CSD} = V _{SS} +5 V
t _{SD}	Shutdown propagation delay from V _{CSD} > V _{SS} + V _{th} _{OCH} to Shutdown	-	-	250	ns	
t _{OCH}	Propagation delay time from V _{CSH} > V _{th} _{OCH} to Shutdown	-	-	500		Fig.3
t _{OCL}	Propagation delay time from Vs> V _{th} _{OCL} to Shutdown	-	-	500		Fig.4
Gate Driver						
I _{o+}	Output high short circuit current (Source)	-	1.0	-	A	V _o =0 V, PW≤10 μs
I _{o-}	Output low short circuit current (Sink)	-	1.2	-	A	V _o =12 V, PW≤10 μs
V _{OL}	Low level out put voltage LO – COM, HO - VS	-	-	0.1	V	I _o =0 A
V _{OH}	High level out put voltage VCC – LO, VB - HO	-	-	1.4		
t _{on}	High and low side turn-on propagation delay	-	360	-	ns	V _{DT} = V _{CC}
t _{off}	High and low side turn-off propagation delay	-	335	-		V _{DT} = V _{CC}
t _r	Turn-on rise time	-	20	50		
t _f	Turn-off fall time	-	15	35		
DT1	Deadtime: LO turn-off to HO turn-on (DT _{LO-HO}) & HO turn-off to LO turn-on (DT _{HO-LO})	15	25	35		V _{DT} >V _{DT1} ,
DT2	Deadtime: LO turn-off to HO turn-on (DT _{LO-HO}) & HO turn-off to LO turn-on (DT _{HO-LO})	25	40	55		V _{DT1} >V _{DT} > V _{DT2} ,
DT3	Deadtime: LO turn-off to HO turn-on (DT _{LO-HO}) & HO turn-off to LO turn-on (DT _{HO-LO})	50	65	85		V _{DT2} >V _{DT} > V _{DT3} ,
DT4	Deadtime: LO turn-off to HO turn-on (DT _{LO-HO}) & HO turn-off to LO turn-on (DT _{HO-LO})V _{DT} = V _{DT4}	85	105	135		V _{DT3} >V _{DT} > V _{DT4} ,
V _{DT1}	DT mode select threshold 2	0.51xVcc	0.57xVcc	0.63xVcc	V	
V _{DT2}	DT mode select threshold 3	0.32xVcc	0.36xVcc	0.40xVcc		
V _{DT3}	DT mode select threshold 4	0.21xVcc	0.23xVcc	0.25xVcc		

Waveform Definitions

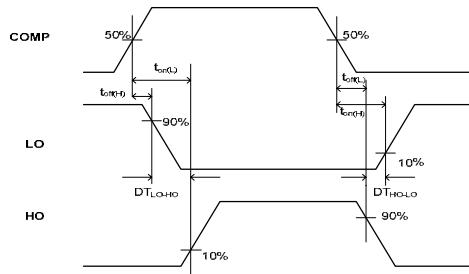


Figure 1: Switching Time Waveform Definitions

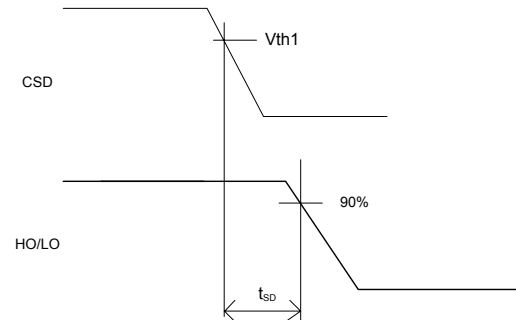


Figure 2: CSD to Shutdown Waveform Definitions

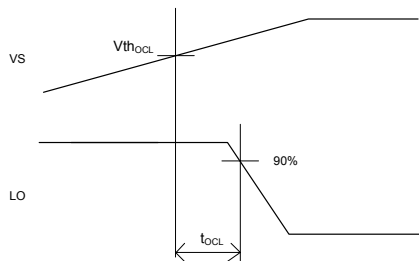


Figure 3: $V_S > V_{th_{OCL}}$ to Shutdown Waveform

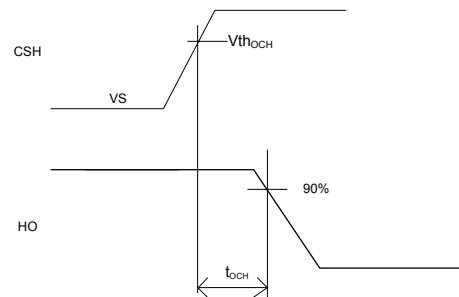


Figure 4: $V_{CSH} > V_{th_{OCH}}$ to Shutdown Waveform

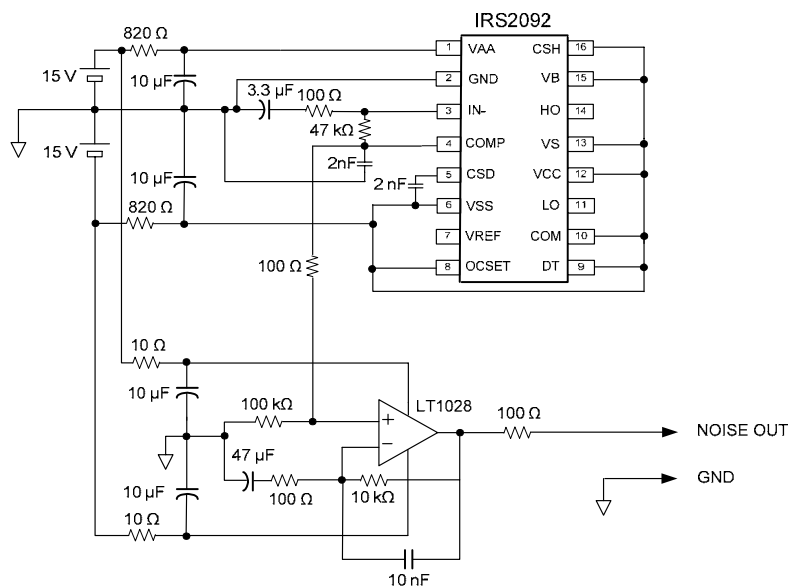
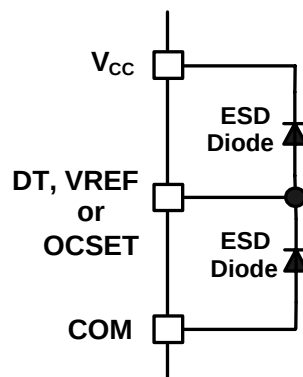
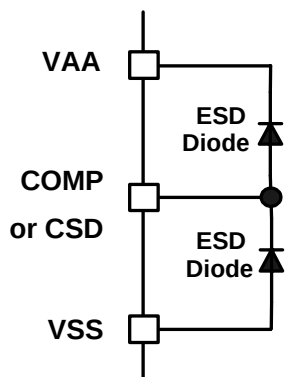
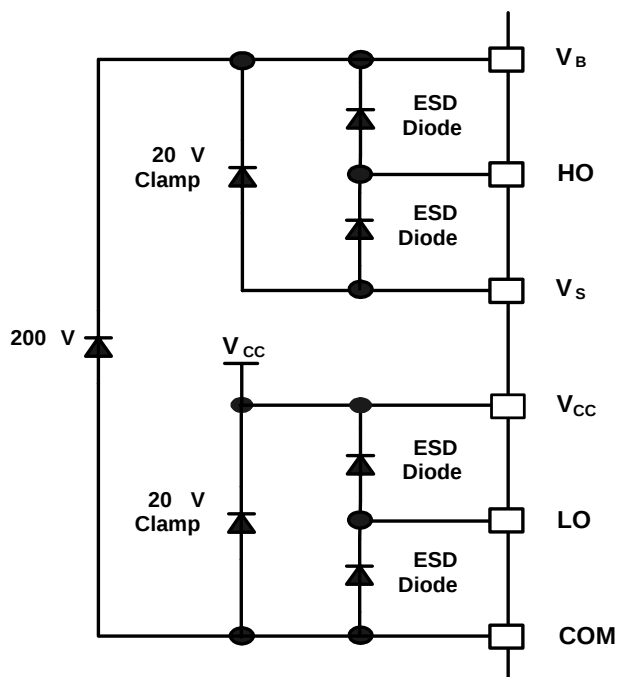
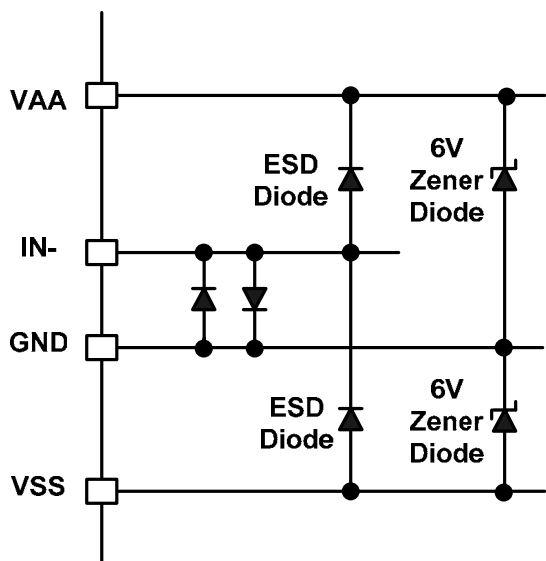


Figure 5: OTA input noise voltage measurement circuit

The schematic diagram illustrates the internal architecture of the HVPS01 high-voltage power supply controller. The circuit is organized into several functional blocks:

- Input and Biasing:** The VAA pin provides the main supply voltage. The IN- pin is connected to a network of diodes and resistors. The GND pin is the common ground. The COMP pin is connected to the OTA. The VSS pin is connected to ground through a 6V diode. The CSD pin is connected to the CHARGE/DISCHARGE input of the PROTECTION CONTROL block.
- Control and Protection:** The OTA (Operational Transconductance Amplifier) is configured with a feedback network of diodes and resistors. Its output is connected to a COMP (Comparator) and a PWM MODULATOR. The PWM MODULATOR also receives a CLICK NOISE ELLIMINATION signal. The output of the PWM MODULATOR is connected to the HV LEVEL SHIFT block. The PROTECTION CONTROL block receives inputs from the CHARGE/DISCHARGE pin and the HV LEVEL SHIFT block. It outputs a signal to the HV LEVEL SHIFT block and a signal to the DEAD TIME block.
- High-Side Driver:** The HV LEVEL SHIFT block drives the HIGH SIDE CS (Common Source) driver. The HIGH SIDE CS driver is connected to the CSH pin. The output of the HIGH SIDE CS driver is connected to the UV DETECT block. The UV DETECT block outputs a signal to the HO pin. The HO pin is connected to the VS pin through a 20.4V diode. The VS pin is connected to the COM pin through a 20.4V diode.
- Low-Side Driver:** The LOW SIDE CS (Common Source) driver is connected to the VREF pin. The output of the LOW SIDE CS driver is connected to the OCSET pin. The OCSET pin is connected to the DT pin through a 20.4V diode. The DT pin is connected to the COM pin through a 20.4V diode.
- Other Components:** The 5V REG (5V Regulator) provides a stable 5V supply to the UV DETECT block. The DEAD TIME block receives inputs from the HV LEVEL SHIFT block and the PROTECTION CONTROL block. The DEAD TIME block outputs a signal to the HV LEVEL SHIFT block.

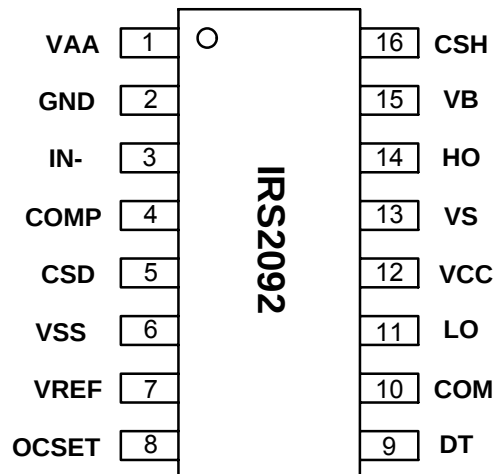
Input/Output Pin Equivalent Circuit Diagrams: IRS2092



Lead Definitions: IRS2092

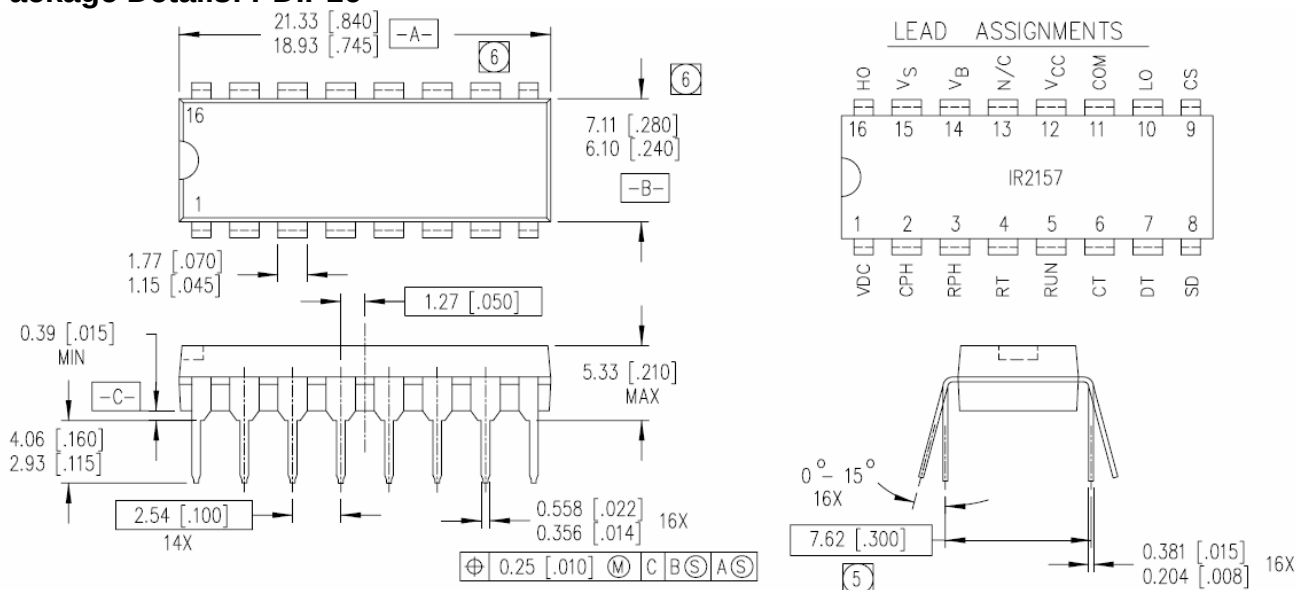
Pin #	Symbol	Description
1	VAA	Floating input positive supply
2	GND	Floating input supply return
3	IN-	Analog inverting input
4	COMP	Phase compensation input, comparator input
5	CSD	Shutdown timing capacitor
6	VSS	Floating input negative supply
7	VREF	5V reference voltage to program OCSET pin
8	OCSET	Low side over current threshold setting
9	DT	Deadtime program input
10	COM	Low side supply return
11	LO	Low side output
12	VCC	Low side supply
13	VS	High side floating supply return
14	HO	High side output
15	VB	High side floating supply
16	CSH	High side over current sensing input

Lead Assignments



PDIP16 and SOIC16N

Package Details: PDIP16

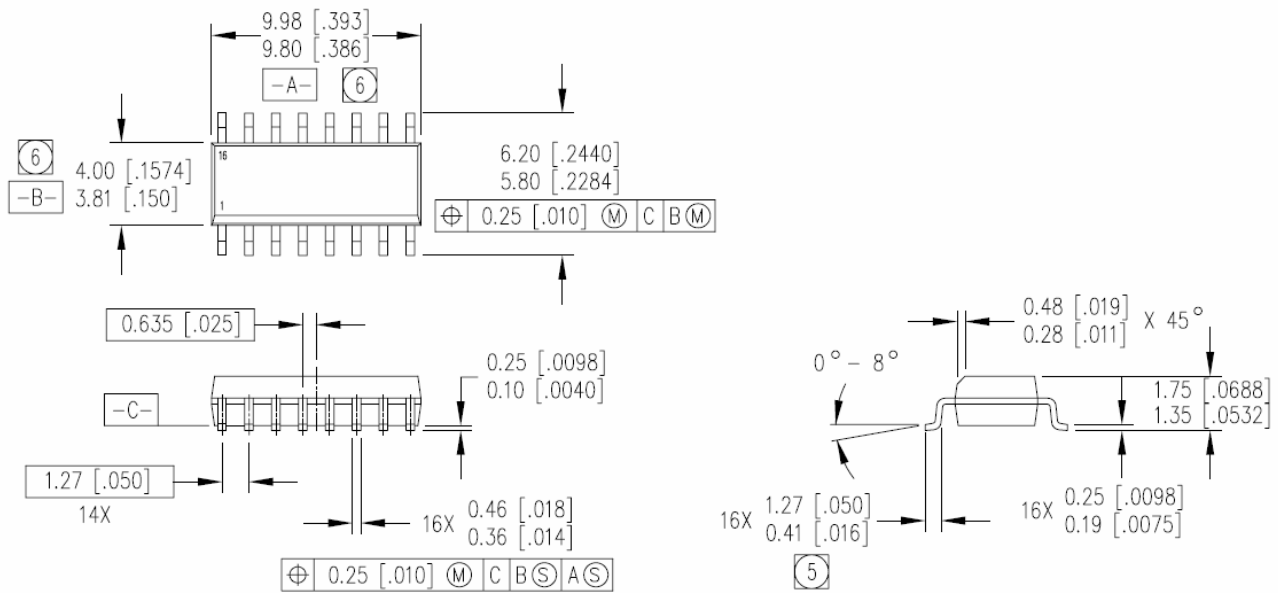


NOTES:

- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
- 2 CONTROLLING DIMENSION: INCH.
- 3 DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4 OUTLINE CONFORMS TO JEDEC OUTLINE MS-001AA.

- 5 MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.
- 6 DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 [.010].

Package Details: SOIC16N

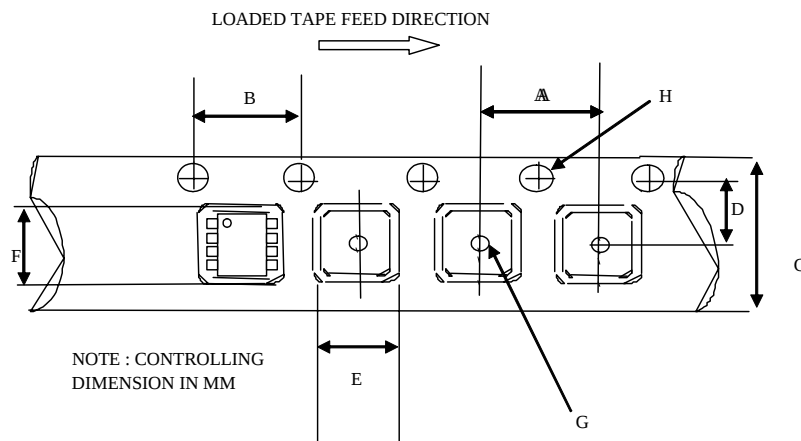


NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AC.

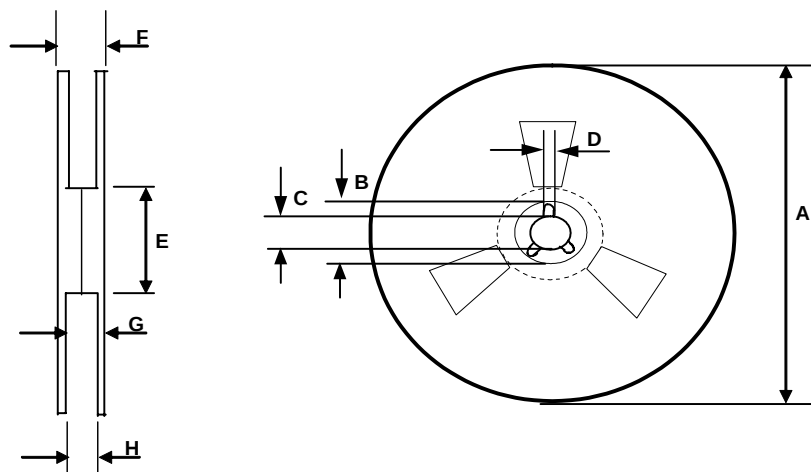
- (5) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.15 [.006].

Tape and Reel Details: SOIC16N



CARRIER TAPE DIMENSION FOR 16SOICN

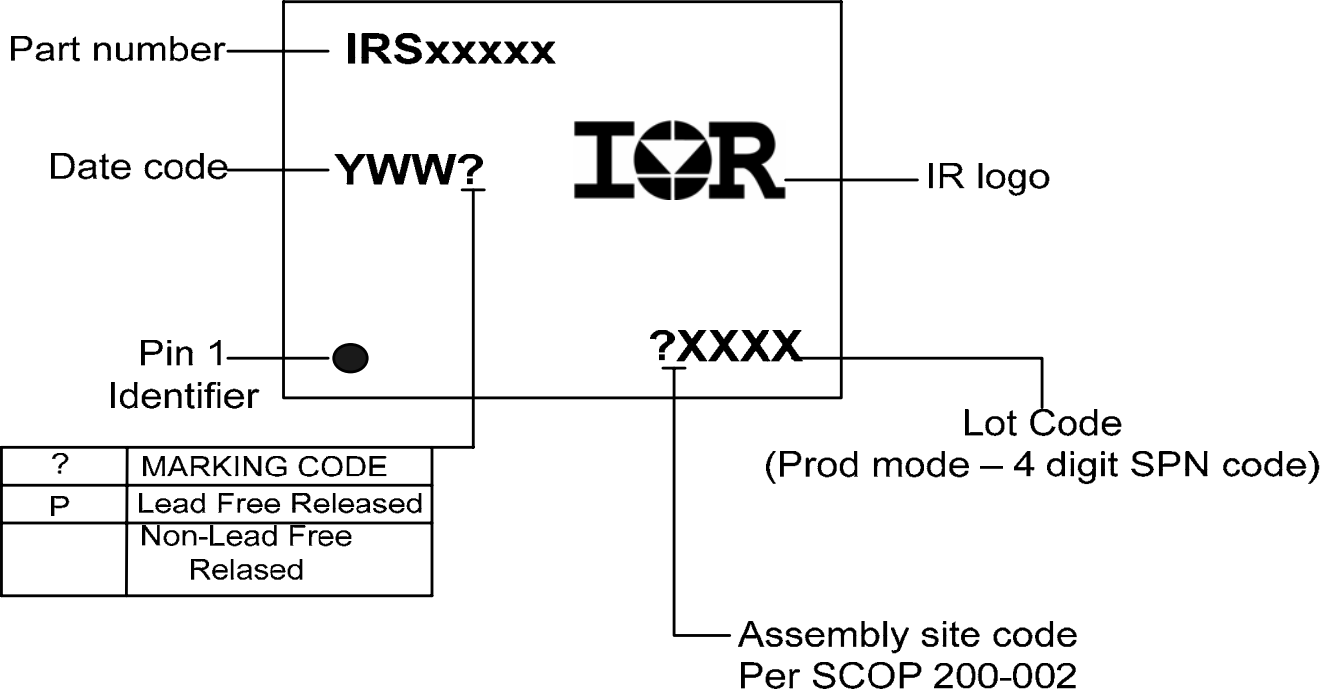
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	15.70	16.30	0.618	0.641
D	7.40	7.60	0.291	0.299
E	6.40	6.60	0.252	0.260
F	10.20	10.40	0.402	0.409
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 16SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	22.40	n/a	0.881
G	18.50	21.10	0.728	0.830
H	16.40	18.40	0.645	0.724

Part Marking Information



Ordering Information

Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
IRS2092	PDIP16	Tube/Bulk	25	IRS2092PBF
	SOIC16N	Tube/Bulk	45	IRS2092SPBF
		Tape and Reel	2500	IRS2092STRPBF

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For technical support, please contact IR's Technical Assistance Center

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